

Trench IGBT

Copack

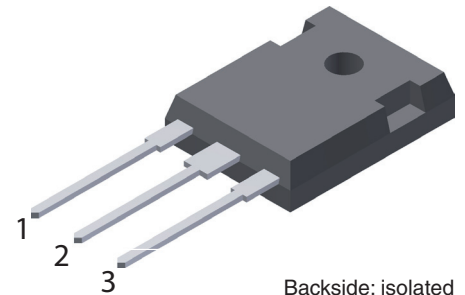
$$V_{CES} = 1200 \text{ V}$$

$$I_{C25} = 72 \text{ A}$$

$$V_{CE(sat)} = 2.05 \text{ V}$$

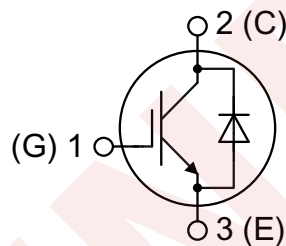
Part number

ITF48IF1200HR



Backside: isolated

E72873



Features / Advantages:

- Easy paralleling due to the positive temperature coefficient of the on-state voltage
- Fast Trench IGBT
 - very low $V_{CE(sat)}$
 - short circuit rated for 10 μsec .
 - very low gate charge
 - low EMI
 - square RBSOA @ $3 \times I_C$
- Sonic™ diode
 - fast and soft reverse recovery
 - low operating forward voltage

Applications:

- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning system
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

Package: ISO247

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Soldering pins for PCB mounting
- Backside: DCB ceramic
- Reduced weight
- Advanced power cycling

Terms & Conditions of usage

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact the sales office, which is responsible for you. Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

- to perform joint risk and quality assessments;

- the conclusion of quality agreements;

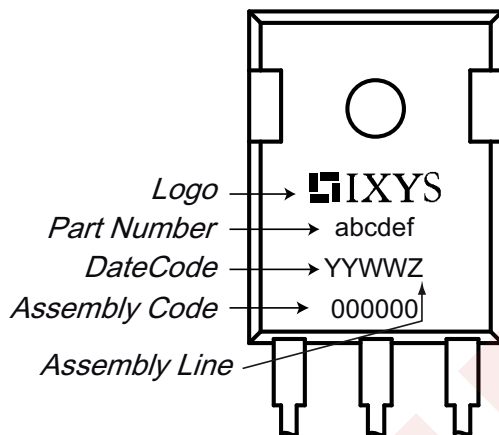
- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IGBT				Ratings			
Symbol	Definitions	Conditions		min.	typ.	max.	
V_{CE}	collector emitter voltage	$T_{VJ} = 25^{\circ}\text{C}$				1200	V
V_{GES}	max. DC gate voltage	$T_{VJ} = 25^{\circ}\text{C}$				± 20	V
I_{C25}	collector current	$T_C = 25^{\circ}\text{C}$				72	A
I_{C80}		$T_C = 80^{\circ}\text{C}$				56	A
I_{C100}		$T_C = 100^{\circ}\text{C}$				48	A
P_{tot}	total power dissipation	$T_C = 25^{\circ}\text{C}$				390	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 40\text{ A}; V_{GE} = 15\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 175^{\circ}\text{C}$		2.05 2.70	2.40	V V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 1.5\text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^{\circ}\text{C}$	5.3	5.8	6.3	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 175^{\circ}\text{C}$		1.5	0.25	mA mA
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20\text{ V}$				600	nA
Q_{Gon}	total gate charge	$V_{CE} = 600\text{ V}; V_{GE} = 0/15\text{ V}; I_C = 40\text{ A}$			175		nC
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600\text{ V}; I_C = 40\text{ A}$ $V_{GE} = 0/15\text{ V}; R_G = 12\ \Omega$ $T_{VJ} = 150^{\circ}\text{C}$			26		ns
t_r	current rise time				26		ns
$t_{d(off)}$	turn-off delay time				350		ns
t_f	current fall time				110		ns
E_{on}	turn-on energy per pulse				3.0		mJ
E_{off}	turn-off energy per pulse				2.4		mJ
$E_{rec(off)}$	reverse recovery losses at turn-off				1.1		mJ
RBSOA	reverse bias safe operating area	$V_{GE} = 15\text{ V};$ $V_{CEmax} = 1200\text{ V}$	$T_{VJ} \leq 175^{\circ}\text{C}$			160	A
SCSOA	short circuit safe operation area	$V_{CE} = 600\text{ V}; V_{GE} = \pm 15\text{ V}$ $R_G = 12\ \Omega; \text{none repetitive}$	$T_{VJ} \leq 175^{\circ}\text{C}$			10	μs
t_{SC}	short circuit duration				140		A
I_{SC}	short circuit current						
R_{thJC}	thermal resistance junction to case					0.38	K/W
R_{thJH}	thermal resistance junction to heatsink	with heat transfer paste (IXYS test setup)			0.6		K/W

Diode							
V_{RRM}	max. repetitive reverse voltage	$T_C = 25^{\circ}\text{C}$				1200	V
I_{F25}	forward current	$T_C = 25^{\circ}\text{C}$				67	A
I_{F80}		$T_C = 80^{\circ}\text{C}$				50	A
I_{F100}		$T_C = 100^{\circ}\text{C}$				43	A
V_F	forward voltage	$I_F = 30\text{ A}$	$T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$		1.95	2.20	V V
Q_{rr}	reverse recovery charge	$V_R = 600\text{ V}$ $-di_F/dt = -1800\text{ A}/\mu\text{s}$ $I_F = 40\text{ A}; V_{GE} = 0\text{ V}$ $T_{VJ} = 150^{\circ}\text{C}$			3.8		μC
I_{RM}	max. reverse recovery current				55		A
t_{rr}	reverse recovery time				250		ns
E_{rec}	reverse recovery losses				1.1		mJ
R_{thJC}	thermal resistance junction to case					0.7	K/W
R_{thJH}	thermal resistance junction to heatsink	with heat transfer paste (IXYS test setup)			1.1		K/W

Package ISO247				Ratings			
Symbol	Definitions	Conditions		min.	typ.	max.	
I _{RMS}	RMS current	per terminal				50	A
T _{stg}	storage temperature			-40		150	°C
T _{op}	operation temperature			-40		150	°C
T _{VJ}	virtual junction temperature			-40		175	°C
Weight					6		g
M _D	mounting torque			0.8		1.2	Nm
F _C	mounting force with clip			40		120	N
d _{Spp/App}	creepage distance on surface /	terminal to terminal		2.7			mm
d _{Spb/Apb}	striking distance through air	terminal to backside		4.1			mm
V _{ISOL}	isolation voltage	t = 1 second t = 1 minute	50/60 Hz; RMS; I _{ISOL} < 1 mA		3600 3000		V V

Product Marking



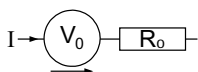
Part number

I = IGBT
 T = IGBT Trench
 F = Fast
 48 = Current Rating [A]
 IF = Copack
 1200 = Reverse Voltage [V]
 HR = ISO247 (3)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	ITF48IF1200HR	ITF48IF1200HR	Tube	30	517181

Equivalent Circuits for Simulation

*on die level

 $T_{VJ} = 175^{\circ}\text{C}$  $V_{0\max}$ threshold voltage $R_{0\max}$ slope resistance *

IGBT

Diode

0.88

1.2

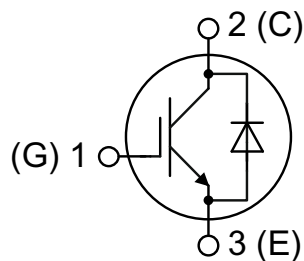
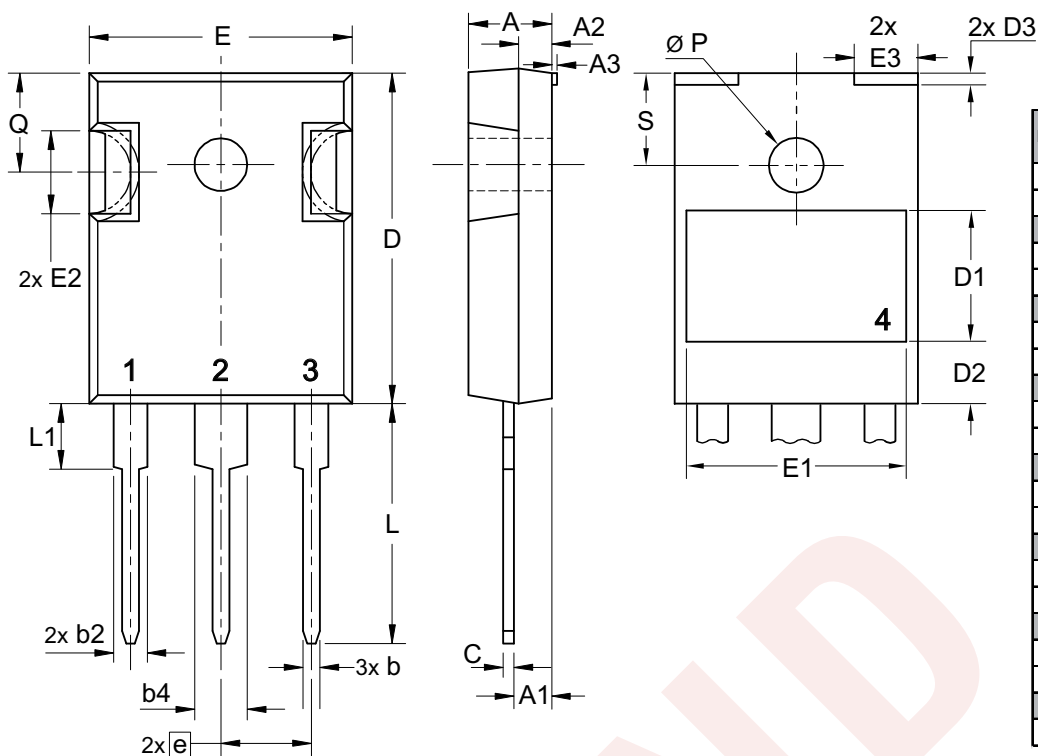
V

58

30

mΩ

Outlines ISO247



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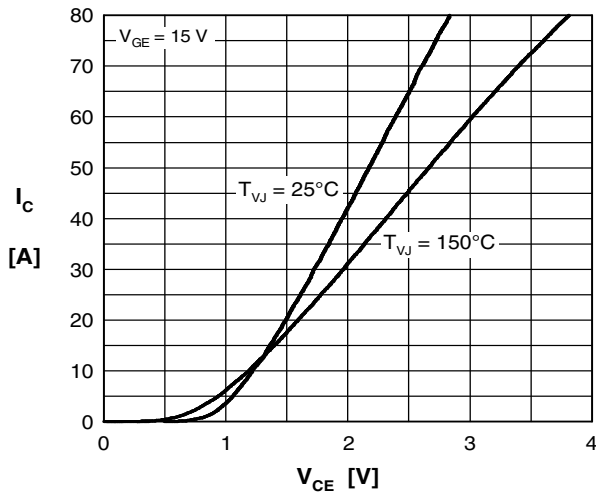


Fig. 1 Typ. output characteristics

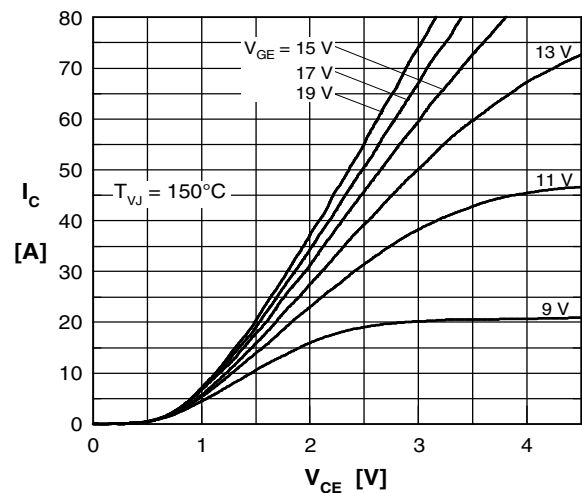


Fig. 2 Typ. output characteristics

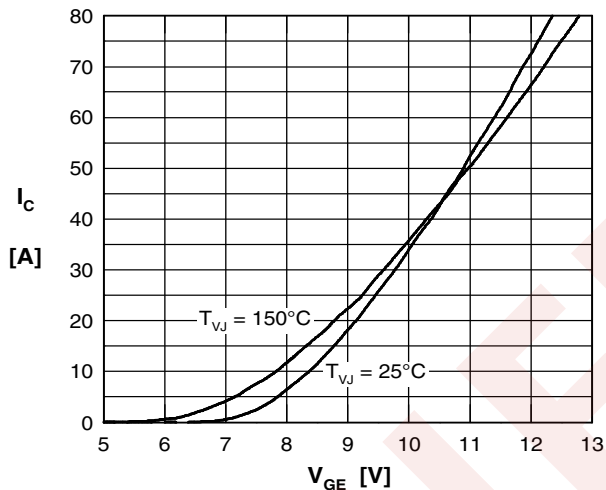


Fig. 3 Typ. transfer characteristics

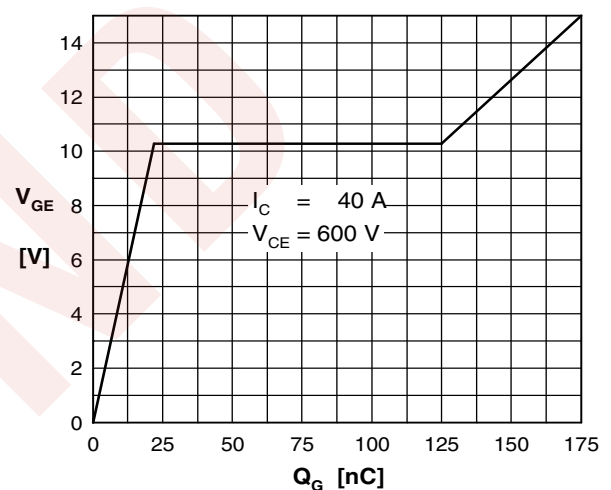


Fig. 4 Typ. turn-on gate charge

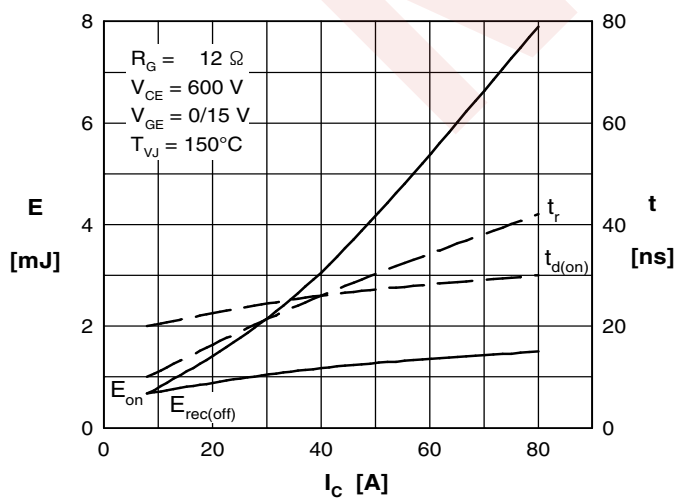


Fig. 5 Typ. turn-on energy & switching times versus collector current

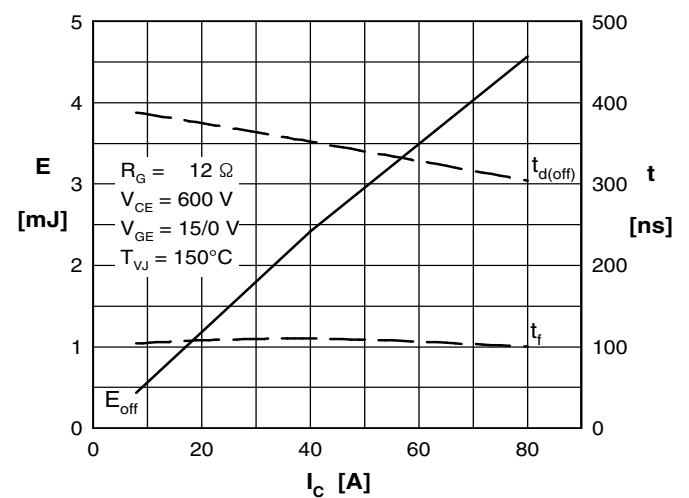


Fig. 6 Typ. turn-off energy & switching times versus collector current

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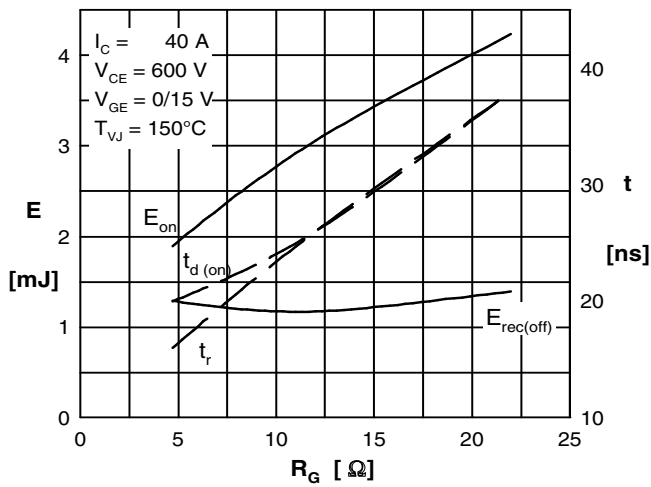


Fig. 7 Typ. turn-on energy and switching times versus gate resistor

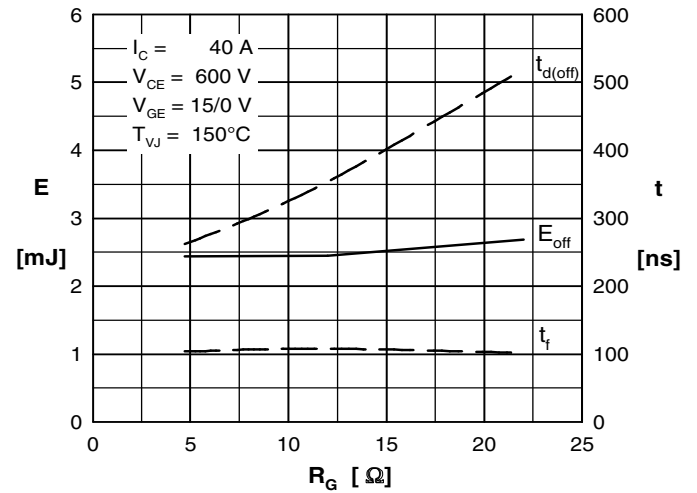


Fig. 8 Typ. turn-off energy and switching times versus gate resistor

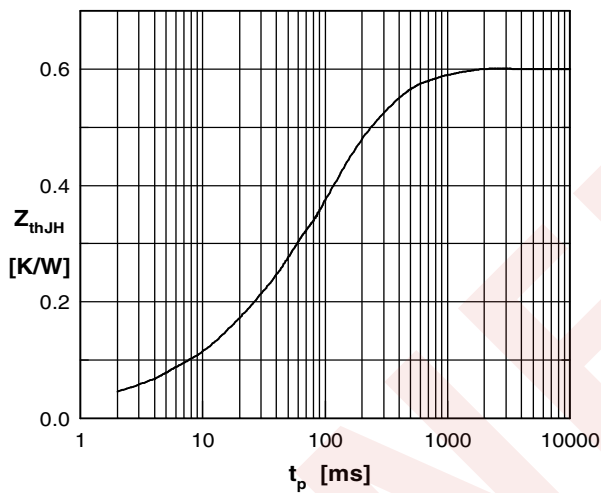


Fig. 9 Typ. transient thermal impedance

DIODE

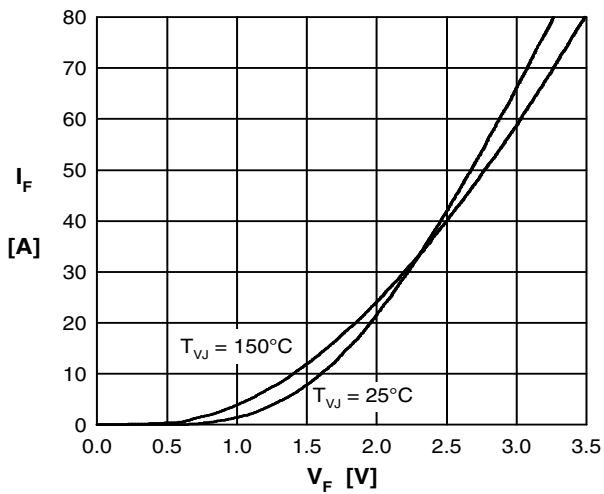


Fig. 10 Typ. forward characteristics

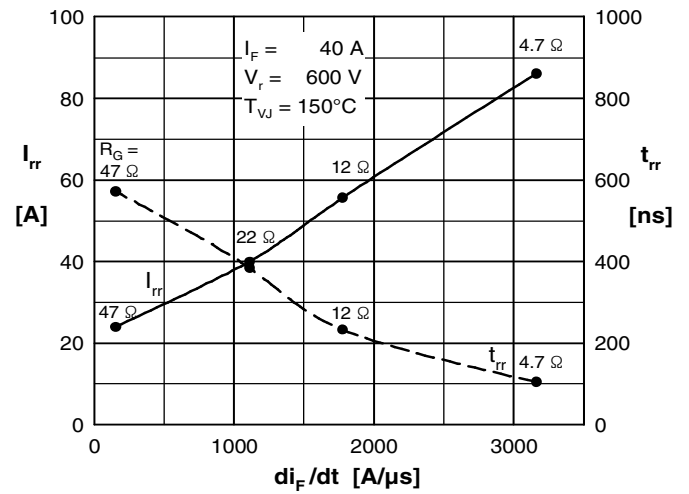


Fig. 11 Typ. reverse recovery characteristics

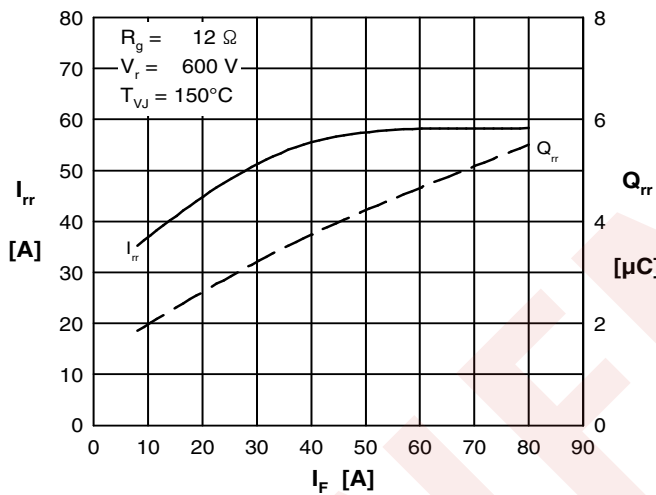


Fig. 12 Typ. reverse recovery characteristics

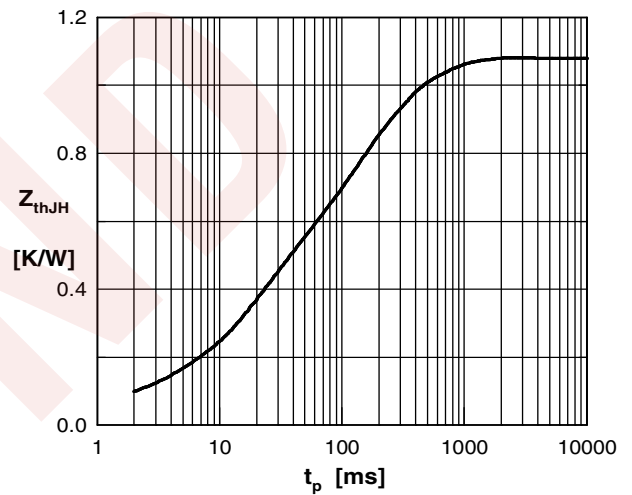


Fig. 13 Typ. transient thermal impedance